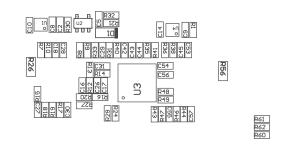


BOARD #:

COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. 001

		PMP4482		REV: A	SVN REV: Not In VersionControl	
		TID #:	PMP4482			
PLOT NAME =	Top Assembly Drawing	GENERATE	3/29/2	2016 11:35:00	AM	TEXAS INSTRUMENTS



REU: A SUN REU:

COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP4482				
	TID #: PMP4482				
PLOT NAME = Bottom Assembly Drawing	GENERATED : 3/29/2016 11:35:01 AM	TEXAS INSTRUMENTS			

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